

P6T WS Professional Motherboard Qualified Vendors Lists (QVL) DDR3-1600MHz capability

Vendor	Part No.	Size	SS/ DS	Chip No.	CL	Chip Brand	DIMM socket support (Optional)			
							A*	B*	C*	D*
CORSAIR	CM3X1024-1600C7DHXIN(XMP)	1GB	SS	Heat-Sink Package	7	N/A
Crucial	BL12864BA1608.8SFB(XMP)	1GB	SS	Heat-Sink Package	N/A	PQI
G.SKILL	F3-12800CL7D-2GBHZ	2GB (Kit of 2)	SS	Heat-Sink Package	7-7-7-18	N/A
G.SKILL	F3-12800CL7D-4GBPI	4GB (Kit of 2)	DS	Heat-Sink Package	7-7-7-18	N/A
Kingston	KHX12800D3K2/4G	4GB (Kit of 2)	SS	Heat-Sink Package	N/A	N/A
OCZ	OCZ3P16002GK	2GB (Kit of 2)	SS	Heat-Sink Package	7	N/A
OCZ	OCZ3P1600EB1G(XMP)	1GB	SS	Heat-Sink Package	N/A	N/A
OCZ	OCZ3T1600XM2GK	1GB	SS	Heat-Sink Package	N/A	N/A
OCZ	OCZ3P1600EB4GK	4GB (Kit of 2)	DS	Heat-Sink Package	776	N/A
OCZ	OCZ3RPR16004GK	4GB (Kit of 2)	DS	Heat-Sink Package	7	N/A
Aeneon	AXH760UD10-16H	1GB	SS	Heat-Sink Package	9	N/A
Aeneon	AXH860UD20-16H	2GB	DS	Heat-Sink Package	9	N/A
PQI	MFADR322LA0101-08A3	1GB	DS	POD3648S12R	N/A	PQI
Team	BoxP/N:TXD32048M1600HC7DC (TXD31024M1600HC7)	2GB (Kit of 2)	SS	Heat-Sink Package	7-7-7-21	N/A

P6T WS Professional Motherboard Qualified Vendors Lists (QVL) DDR3-1333MHz capability

Vendor	Part No.	Size	SS/ DS	Chip No.	CL	Chip Brand	DIMM socket support (Optional)			
							A*	B*	C*	D*
A-DATA	SC6311B16	2GB	DS	K4B1G0846D	9	SAMSUNG
CORSAIR	BoxP/N:TW3X4G1333C9DHX (CM3X2048-1333C9DHX)	4GB (Kit of 2)	DS	Heat-Sink Package	9-9-9-24	N/A
CORSAIR	BoxP/N:TWIN3X2048-1333C9 (CM3X1024-1333C9)	2GB (Kit of 2)	DS	Heat-Sink Package	9-9-9-24	N/A
CORSAIR	CM3X1024-1333C9DHX	1GB	DS	Heat-Sink Package	9	N/A
crucial	CT12864BA1339.8SFB	1GB	SS	D9GTS	9	MICRON
crucial	CT25664BA1339.16SFD	2GB	DS	D9JNM	9	MICRON
ELPIDA	EBJ11UD8BAFA-DG-E	1GB	DS	J5308BASE-DG-E	8	ELPIDA
G.SKILL	F3-10600CL7D-2GBPI	2GB (Kit of 2)	SS	Heat-Sink Package	7-7-7-18	N/A
G.SKILL	F3-10600CL8D-2GBHK	2GB (Kit of 2)	SS	Heat-Sink Package	8-8-8-21	N/A
G.SKILL	F3-10600CL9D-2GBPK	2GB (Kit of 2)	SS	Heat-Sink Package	9-9-9-24	N/A
G.SKILL	F3-10600CL9D-2GBNQ	2GB (Kit of 2)	DS	Heat-Sink Package	9-9-9-24	N/A

P6T WS Professional Motherboard Qualified Vendors Lists (QVL) DDR3-1333MHz capability (continued)

Vendor	Part No.	Size	SS/ DS	Chip No.	CL	Chip Brand	DIMM socket support (Optional)			
							A*	B*	C*	D*
G.SKILL	F3-10666CL9D-4GBPK	4GB (Kit of 2)	DS	Heat-Sink Package	9-9-9-24	N/A	*	*	*	*
KINGMAX	FLFD45F-B8EE9	1GB	SS	J1108BASE-DJ-E	N/A	ELPIDA	*	*	*	*
Kingston	KVR1333D3N9/1G	1GB	SS	J1108BASE-DJ-E	N/A	ELPIDA	*	*	*	*
Kingston	KVR1333D3N9/2G	2GB	DS	J1108BASE-DJ-E	N/A	ELPIDA	*	*	*	*
MICRON	MT8JTF12864AY-1G4BYTES	1GB	SS	Z9HWR	9	MICRON	*			
MICRON	MT16JTF25664AY-1G4BYTES	2GB	DS	Z9HWR	9	MICRON	*	*	*	*
OCZ	OC23RPX1333EB2GK	1GB	SS	Heat-Sink Package	6-5-5	N/A	*	*		
OCZ	OC23P13332GK	1GB	DS	Heat-Sink Package	7-7-7-20	N/A	*			
OCZ	OC23P13334GK	4GB (Kit of 2)	DS	Heat-Sink Package	7	N/A	*	*	*	
OCZ	OC23RPX1333EB4GK	4GB (Kit of 2)	DS	Heat-Sink Package	6 5 5	N/A	*		*	
Qimonda	IMSH1GU03A1F1C-13H	1GB	SS	IDSH1G-03A1F1C-13H	N/A	N/A	*	*	*	*
Qimonda	IMSH2GU13A1F1C-13H	2GB	DS	IDSH1G-03A1F1C-13H	N/A	N/A	*	*	*	*
SAMSUNG	M378B2873DZ1-CH9	1GB	SS	K4B1G0846D	9	SAMSUNG	*	*	*	*
SAMSUNG	M391B2873DZ1-CH9	1GB	SS	K4B1G0846D(ECC)	9	SAMSUNG	*	*	*	*
SAMSUNG	M378B5673DZ1-CH9	2GB	DS	K4B1G0846D	9	SAMSUNG	*	*	*	*
SAMSUNG	M391B5673DZ1-CH9	2GB	DS	K4B1G0846D(ECC)	9	SAMSUNG	*	*	*	*
Transcend	TS128MLK64V3U	1GB	SS	K4B1G0846D	9	SAMSUNG	*	*	*	
Transcend	TS256MLK64V3U	2GB	DS	K4B1G0846D	9	SAMSUNG	*	*	*	
Aeneon	AEH760UD00-13H	1GB	DS	AEH93R13H	9	AENEON	*	*	*	*
BUFFALO	FSX1333D3G-1G	1GB	SS	Heat-Sink Package	7-7-7-20	N/A	*	*	*	*
BUFFALO	FSX1333D3G-2G	2GB	DS	Heat-Sink Package	7-7-7-20	N/A	*	*	*	*
Elixir	M2F2G64CB8HA4N-CG	2GB	DS	N2CB1G80AN-CG	9	Elixir	*	*	*	*
Patriot	PDC32G1333LLK	1GB (Kit of 2)	SS	Heat-Sink Package	7	Patriot	*	*	*	*
Kingston	KHX11000D3ULK2/2G	DDR3 1375 2GB (Kit of 2)	DS	Heat-Sink Package	N/A	N/A	*	*	*	

P6T WS Professional Motherboard Qualified Vendors Lists (QVL) DDR3-1066MHz capability

Vendor	Part No.	Size	SS/ DS	Chip No.	CL	Chip Brand	DIMM socket support (Optional)			
							A*	B*	C*	D*
CORSAIR	CM3X1024-1066C7	1GB	DS	Heat-Sink Package	7	N/A
Crucial	CT12864BA1067.8SFB	1GB	SS	Z9HWQ	7	MICRON
crucial	CT12864BA1067.8SFD	1GB	SS	D9JNL	7	MICRON
Crucial	CT25664BA1067.16SFD	2GB	DS	D9JNL	7	MICRON
ELPIDA	EBJ11RD8BAFA-AE-E	1GB	DS	J5308BASE-AC-E(ECC)	7	ELPIDA
ELPIDA	EBJ11UD8BAFA-AG-E	1GB	DS	J5308BASE-AC-E	8	ELPIDA
G.SKILL	F3-8500CL6D-2GBHK	2GB (Kit of 2)	SS	Heat-Sink Package	6-6-6-15	N/A
Hynix	HMT112U6AFP8C-G7N0	1GB	SS	H5TQ1G83AFP7C7	7	HYNIX
Hynix	HYMT112U6AZNF8-G7	1GB	SS	HY5TQ1G831ZNF8-G7	7	HYNIX
Hynix	HMT125U6AFP8C-G7N0	2GB	DS	H5TQ1G83AFP7C7	7	HYNIX
Hynix	HYMT125U6AZNF8-G7	2GB	DS	HY5TQ1G831ZNF8-G7	7	HYNIX
Kingston	KVR1066D3N71G	1GB	DS	J5308BASE-AC-E	7	ELPIDA
Kingston	KVR1066D3N72G	2GB	DS	K4B1G0846C-ZCF8	N/A	N/A
MICRON	MT8JTF12864AY-1G1D1	1GB	SS	7VD22	7	MICRON
MICRON	MT16JTF25664AY-1G1D1	2GB	DS	7VD22	7	MICRON
Qimonda	IMSH1GU03A1F1C-10F	1GB	SS	IDSH1G-03A1F1C-10F	7	QIMONDA
Qimonda	IMSH1GU03A1F1C-10G	1GB	SS	IDSH1G-03A1F1C-10G	8	QIMONDA
Qimonda	IMSH1GU13A1F1C-10F	1GB	DS	IDSH51-03A1F1C-10F	N/A	QIMONDA
Qimonda	IMSH2GU13A1F1C-10F	2GB	DS	IDSH1G-03A1F1C-10F	7	QIMONDA
Qimonda	IMSH2GU13A1F1C-10G	2GB	DS	IDSH1G-03A1F1C-10G	8	QIMONDA
Aeneon	AEH76UD00-10FA98X	1GB	DS	AEH93R10F	7	AENEON
WINTEC	3DU3191A-10	1GB	DS	IDSH51-03A1F1C-10F	7	QIMONDA



Side(s): SS - Single-sided DS - Double-sided DIMM support:

- **A*:** Supports two (2) modules inserted into slot A1 and B1 as one pair of Dual-channel memory configuration.
- **B*:** Supports three (3) modules inserted into the orange slots (A1, B1 and C1) as one set of Triple-channel memory configuration.
- **C*:** Supports four (4) modules inserted into the orange slots (A1, B1 and C1) and the black slot A2 as one set of Triple-channel memory configuration.
- **D*:** Supports six (6) modules inserted into both the orange slots and the black slots as two set of Triple-channel memory configuration.



Visit the ASUS website for the latest QVL.